



## GN010 Application Note

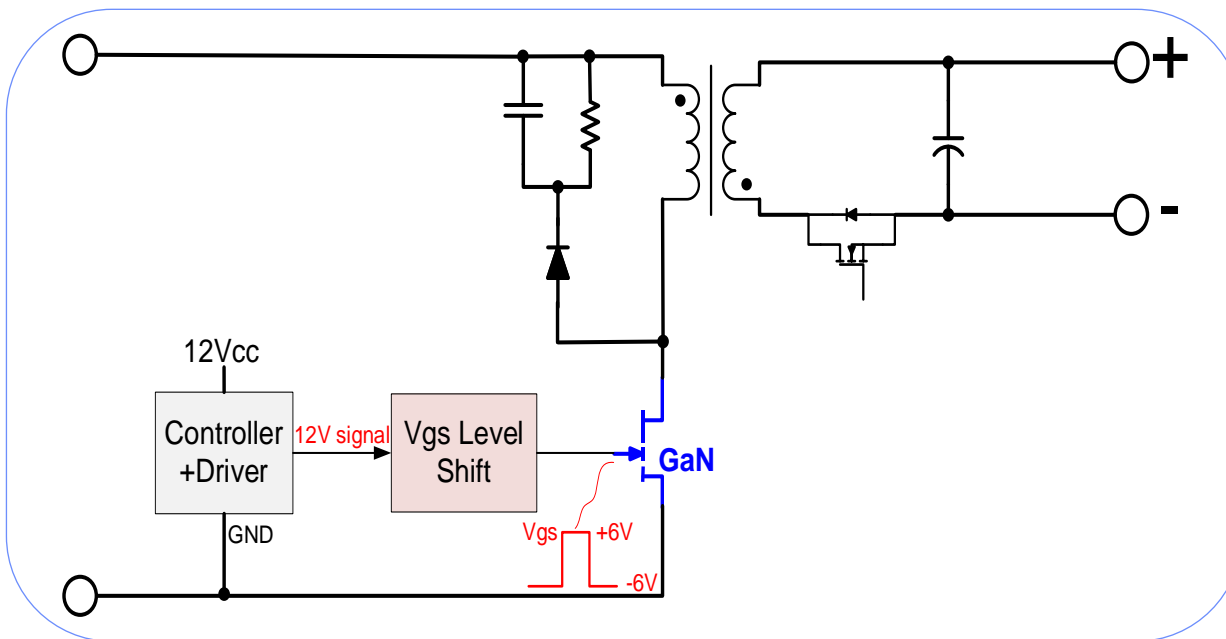
# **EZDrive® Power Stage Solution for GaN Systems' GaN Transistor**

July 2022

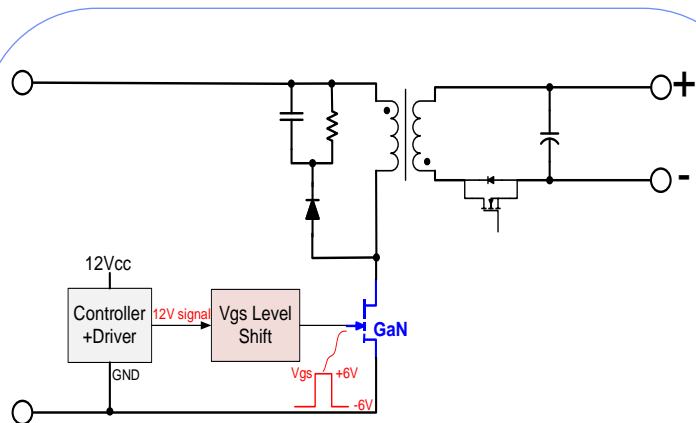
GaN Systems Inc.



- Introduction
- GaN discrete versus integrated options
- GaN Systems' solution: EZDrive circuit
- EZDrive circuit verification
- Summary



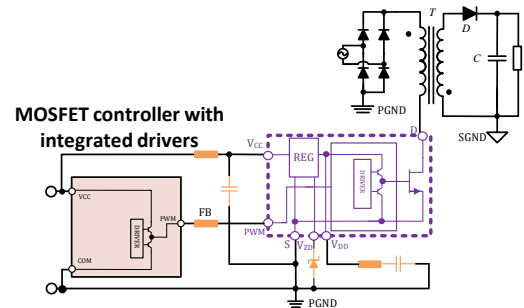
- Controllers with Drive have an output signal of 12V
- The GaN transistor needs +6V for turn on
- Additional V<sub>gs</sub> level shift is needed



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- GaN transistor need +6V for turn on
- Additional Vgs level shift is needed

Integrated

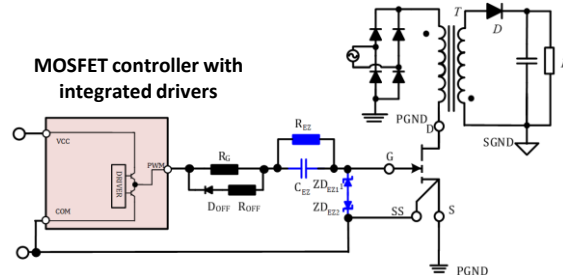
## Monolithic-Integrated GaN



- Internal regulator to convert 12V/0V to +6V/0V

Discrete

## GaN Systems EZDrive Circuit + GaN

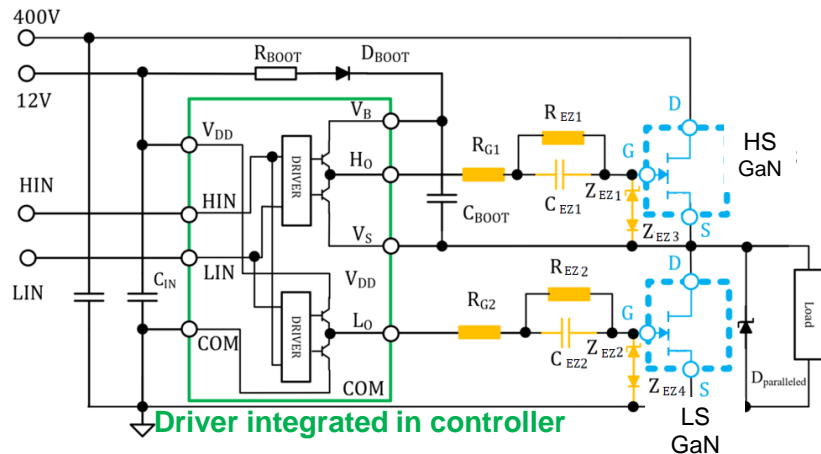


- Level shift circuit<sup>[1]</sup> to convert 12V/0V to +6V/-6V

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# GaN discrete versus integrated design

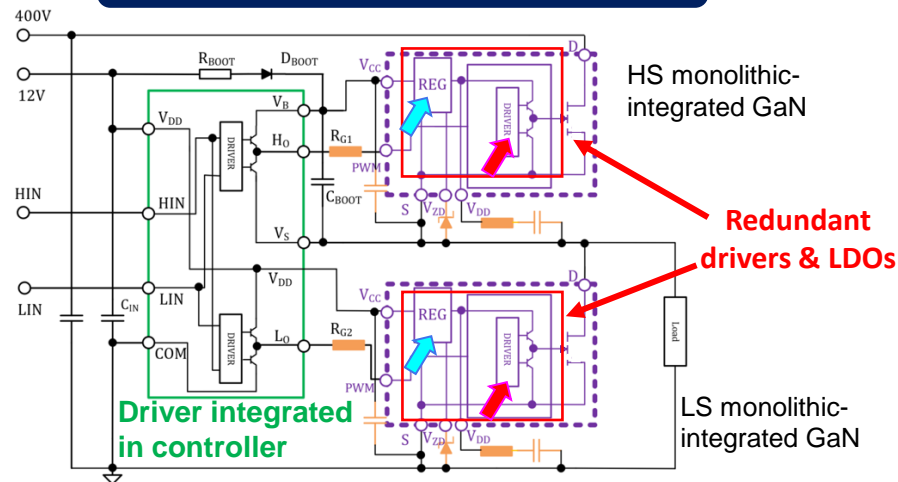
## GaN Systems EZDrive Solution



Fewest circuit blocks + standard componentry  
(cost effective: same number of passive components, no extra driver)

Control Turn-on, turn-off, negative drive  
(optimized EMI and efficiency)

## Monolithic-integrated Solution



Integrated = 2 extra Drivers + 2 extra LDOs  
(higher cost and complexity)

Control of turn-on only  
(sub-optimal performance)

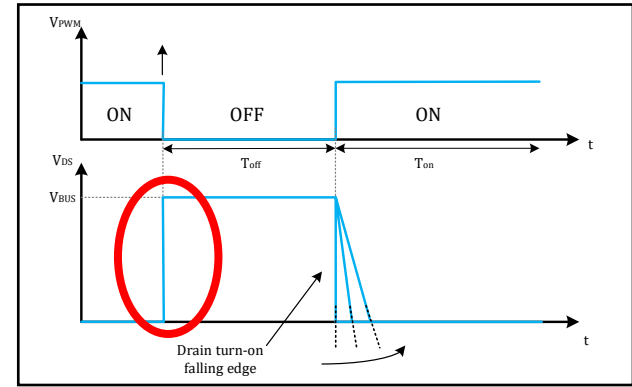
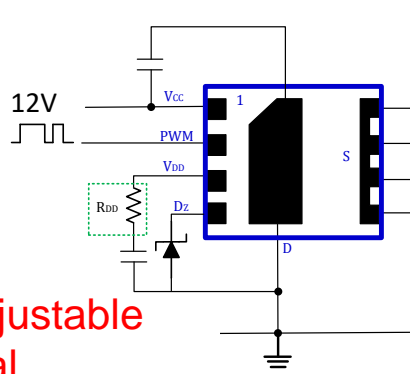


**Discrete solution is lower in cost and better for EMI and efficiency**

# GaN discrete versus integrated $T_{ON}/T_{OFF}$ control

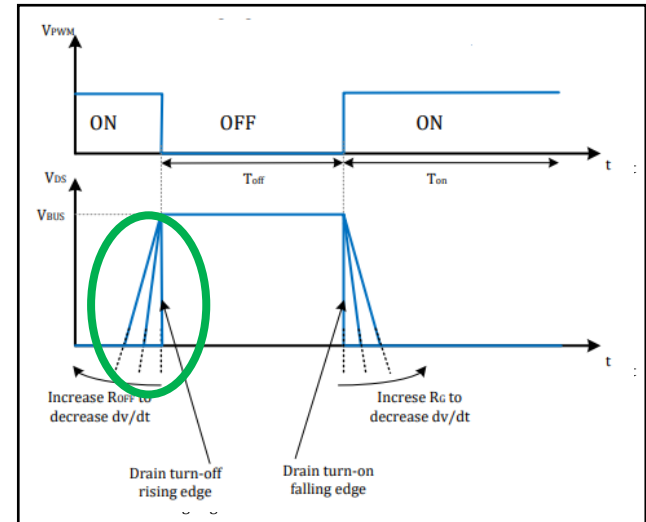
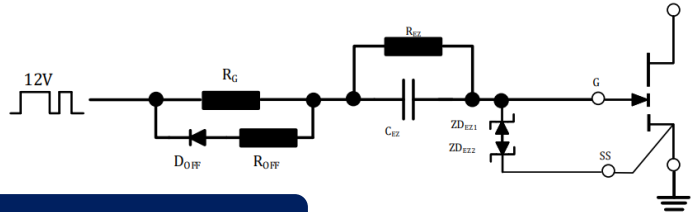
## Monolithic-integrated GaN

- Drain turn-off rising edge NOT adjustable
- Limits design flexibility, not optimal



## Discrete GaN with EZDrive circuit

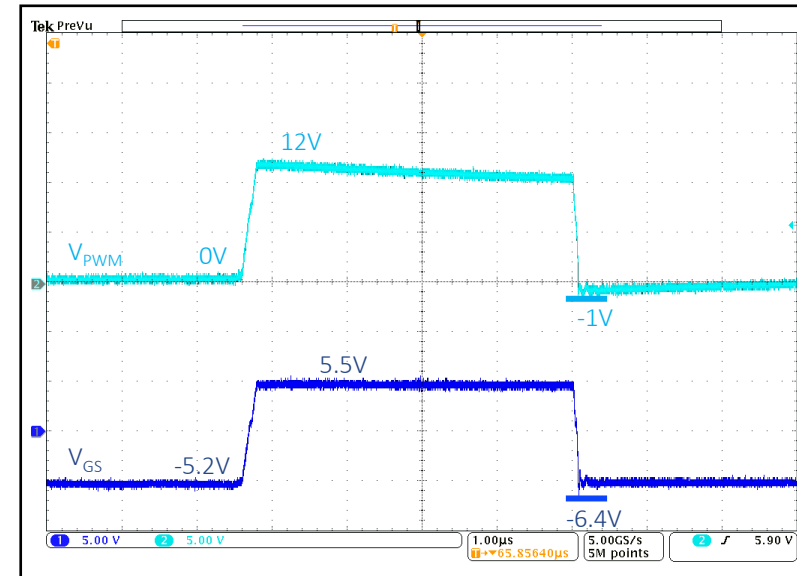
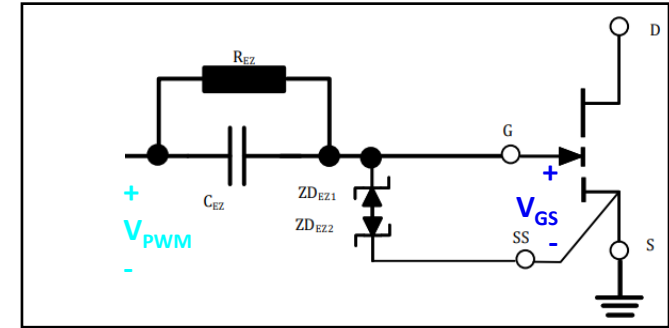
- Drain turn-off rising **AND** turn-on falling edge adjustable
- Optimized EMI and efficiency



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GaN Systems' **EZDrive** circuit is a low cost, easy way to implement a **GaN driving circuit**.

- Not original
- Enables 12V driver to drive 6V GaN
- Level shift circuit composed of 4 components
- Turn ON / OFF slew rate is controllable with external resistors  $R_g$  to optimize EMI
- Adjustable to any power level, any frequency, and any standard controller/driver
- Applies to any controllers with single, dual, or high-side/low-side drivers

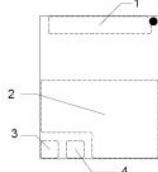


# No.1 Solution: Kelvin Source Examples

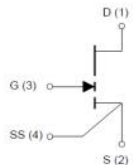
Drive your GaN HEMTs via the source sense (SS) pins:



Package Outline



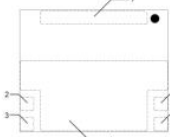
Circuit Symbol



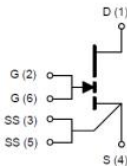
GS66508B



Package Outline



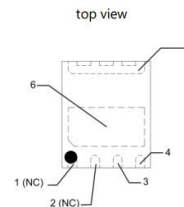
Circuit Symbol



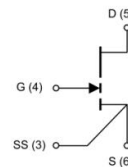
GS66516B



Package Outline



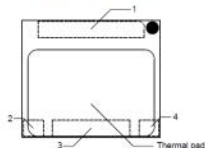
Circuit Symbol



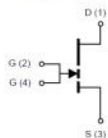
GS-065-011-1-L



Package Outline



Circuit Symbol

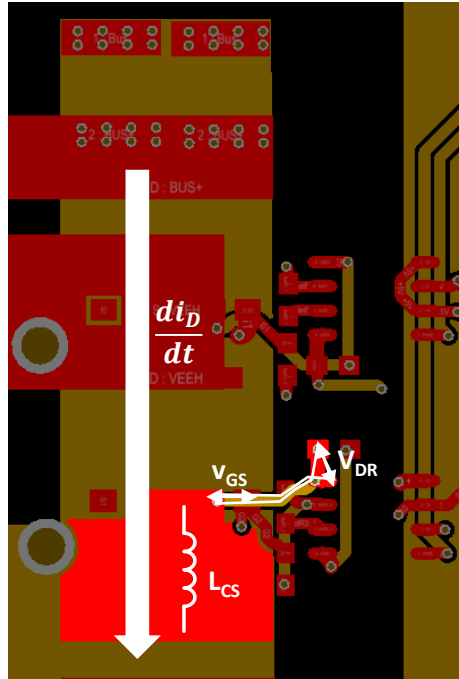
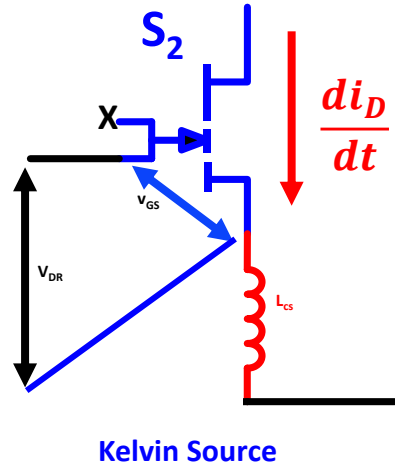


The thermal pad is internally connected to Source (S pin 3) and substrate

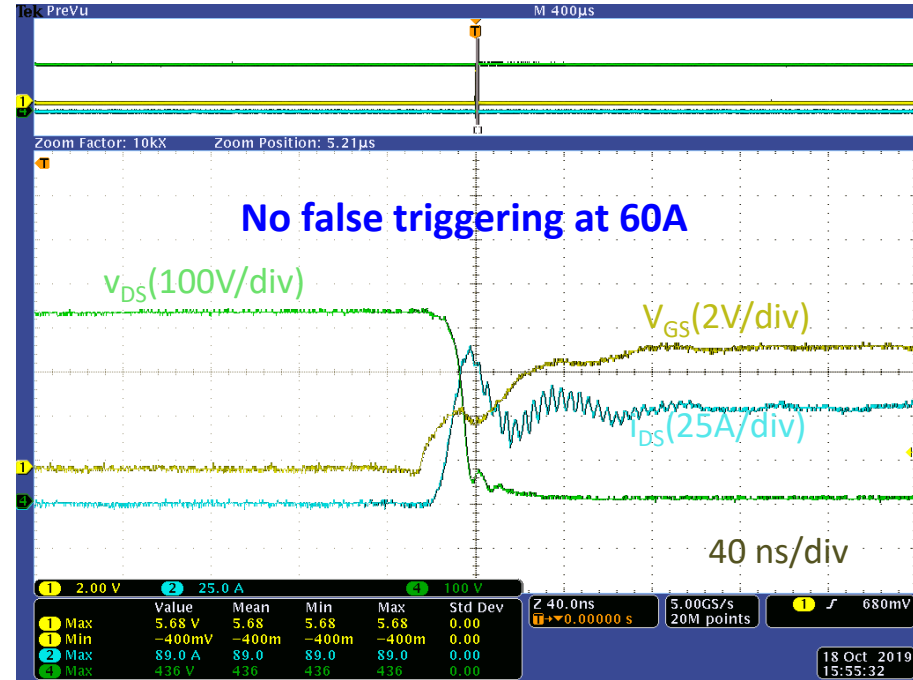
GS66516T

**For devices without source sense, create a Kelvin source in layout as shown in next page.**

# No.1 Solution: Kelvin Source



The control group  
(Optimum design with Kelvin source)

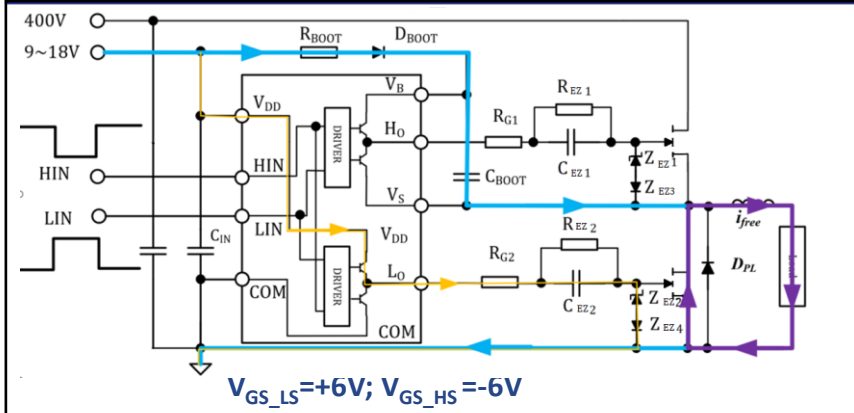


Switching-on @  $V_{BUS}=400V$ ,  $I_{LOAD}=60A$ ,  $R_G=10\Omega$

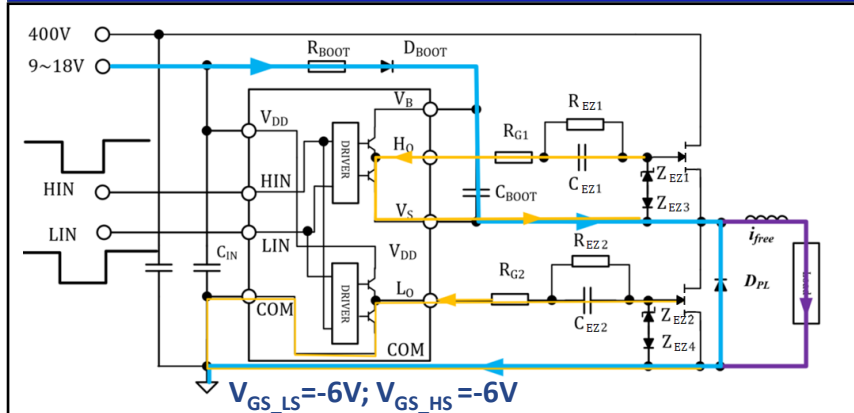
- **Kelvin source** is employed to minimize the coupling between the power loop and gate loop.
- **Predictable and efficient switching transition** is realized at full current with Kelvin source.

# Operation modes of EZDrive solution

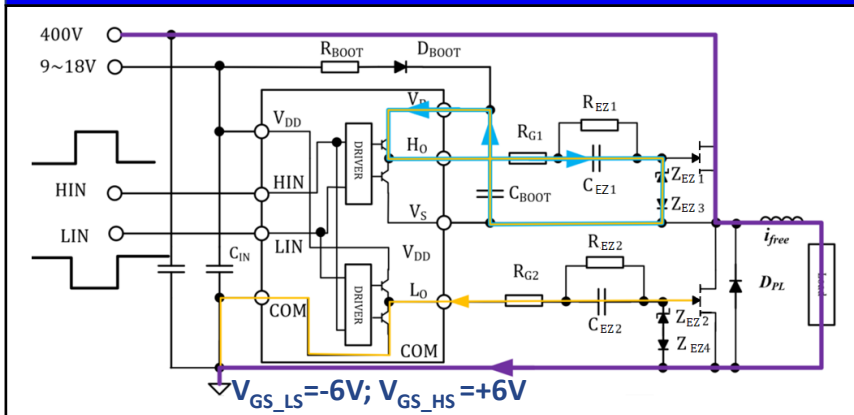
Mode 1:  $C_{BOOT}$  Charging (HS GaN: off; LS GaN: on)



Mode 2:  $C_{BOOT}$  Charging (HS GaN: off; LS GaN: off)



Mode 3:  $C_{BOOT}$  Discharging (HS GaN: on; LS GaN: off)



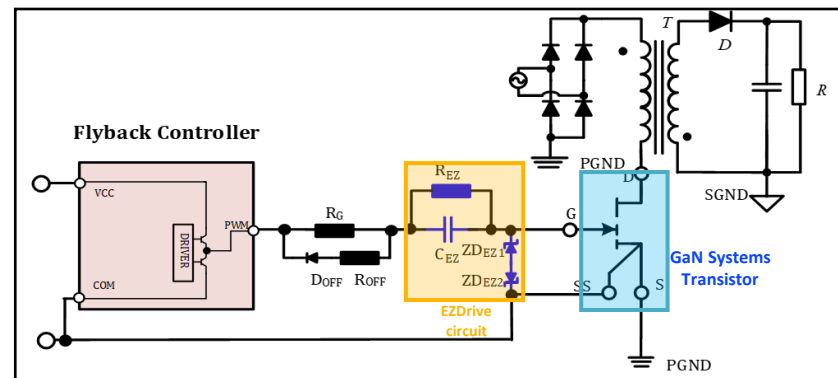
- EZDrive operation modes in half bridge are **similar to** conventional non-isolated Bootstrap high side/low side driver
- Allows **wide controller bias input voltage range** (9~18V)

# EZDrive circuit application examples

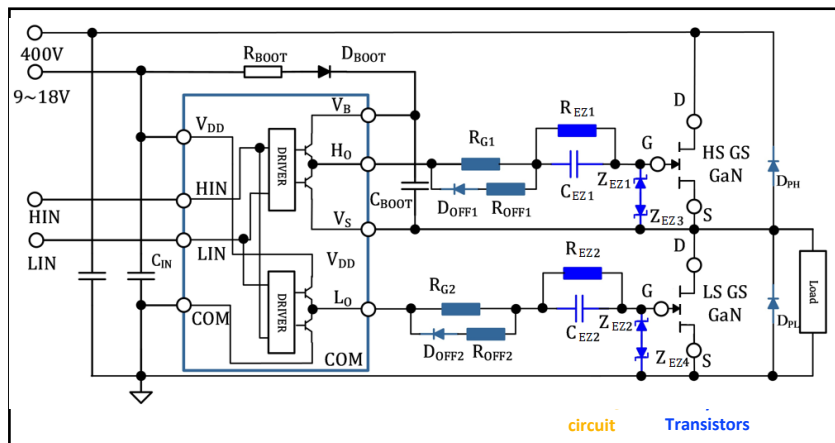
Typical applications with the EZDrive circuit

- Flyback
- Half Bridge
- Boost PFC

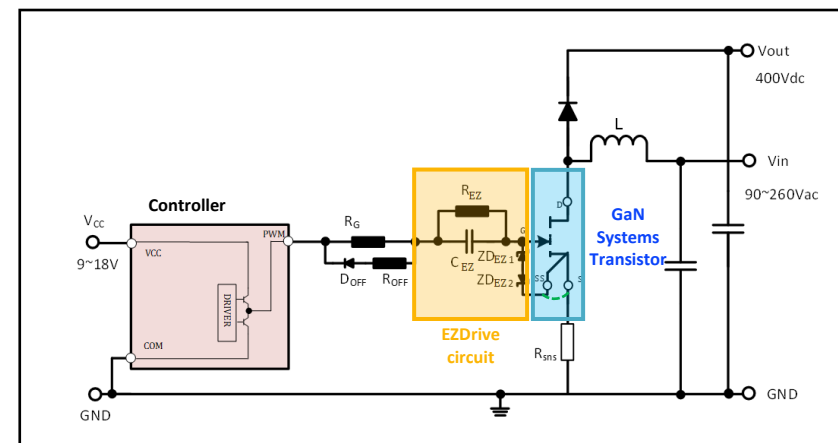
Solution = GaN discrete + EZDrive circuit + Controller



Flyback with EZDrive solution



Half Bridge with EZDrive solution



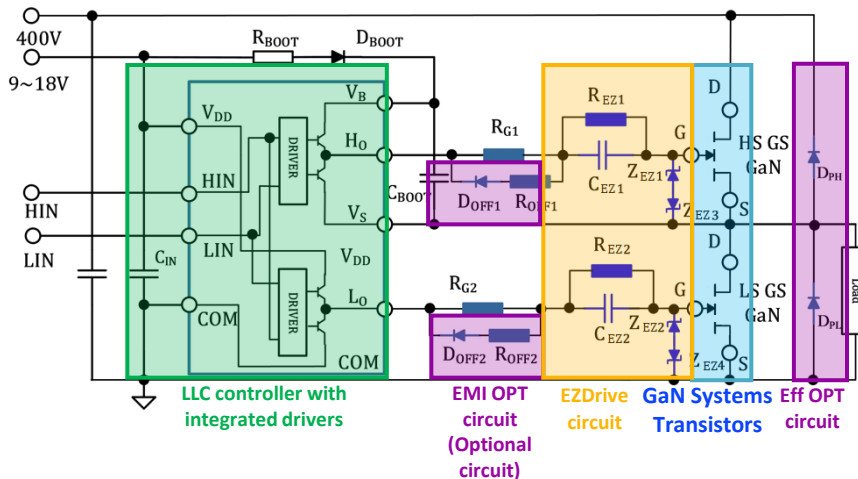
Boost PFC with EZDrive solution

- 
- Flyback Controller**
- VCC
- COM
- PWM
- Flyback controller with integrated driver**
- EMI OPT circuit (Optional circuit)**
- $R_G$
- $D_{OFF}$
- $R_{OFF}$
- EZDrive circuit**
- $R_{EZ}$
- $C_{EZ}$
- $ZD_{EZ1}$
- $ZD_{EZ2}$
- GaN Systems Transistor**
- PGND
- SGND
- $T$
- $D$
- $R$
- $S$
- $G$
- $SS$

Symbol	Value	Footprint	Function
R <sub>EZ</sub>	~ 10 kΩ	0402 / 0603	Keep the driving voltage
C <sub>EZ</sub>	~ 47 nF	0402 / 0603	Hold negative voltage for turning off
Z <sub>EZ1</sub>	5.6 V Zener	SOD923F / 0603	Clamp the positive gate voltage
Z <sub>EZ2</sub>	9.1 V Zener	SOD923F / 0603	Clamp the negative gate voltage

Symbol	Value	Rec. Footprint	Function
D <sub>OFF</sub>	20V Diode 1A	SOD923F / 0603	Enable independent turn-off speed control
R <sub>OFF</sub>	0 Ω	0402 / 0603	Control turn-off speed

- Half Bridge controller examples include NCP1399 and NCP13992
- The circuit and tables show recommended values for the Half Bridge EZDrive circuit
  - As an option, similar to silicon MOSFET-based designs, efficiency and EMI can be further optimized with the labeled “optional circuit”



**EZDrive Circuit**

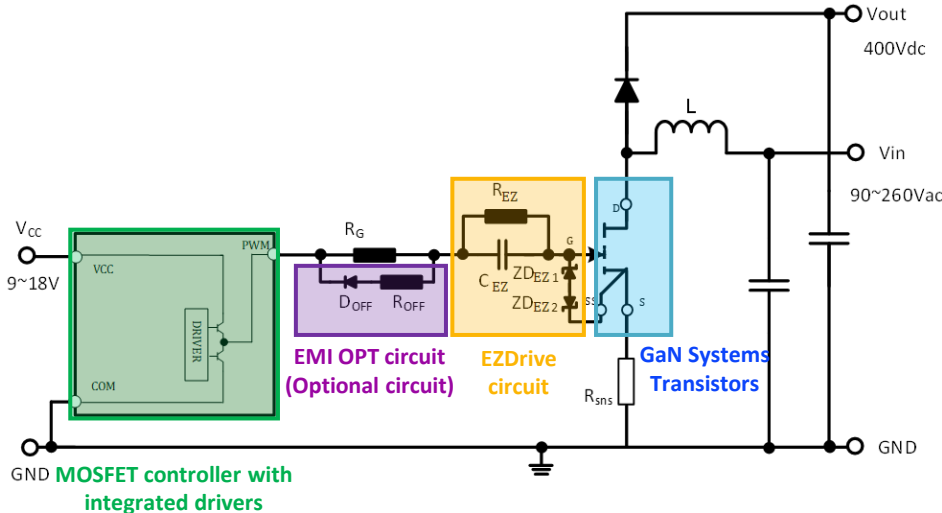
Symbol	Rec. Value	Rec. Footprint	Function
$R_{EZ1,2}$	~ 10 k $\Omega$	0402 / 0603	Keep the driving voltage
$C_{EZ1,2}$	~ 47 nF	0402 / 0603	Hold negative voltage for turning off
$Z_{EZ1,2}$	5.6 V Zener	SOD923F / 0603	Clamp the positive gate voltage
$Z_{EZ3,4}$	9.1 V Zener	SOD923F / 0603	Clamp the negative gate voltage

**Efficiency and EMI Optimization Circuit**

Symbol	Rec. Value	Rec. Footprint	Function
$D_{OFF1,2}$	20V DIODE 1A	SOD923F / 0603	Optional for Enabling independent turn-off speed control
$R_{OFF1,2}$	0 $\Omega$	0402 / 0603	Optional for Controlling turn-off speed
$D_{PL}$	600V FRD 1A	SOD123F / SMA	Avoid $C_{BOOT}$ overcharging, for reduced low side $P_{DT}$ (Note 1)
$D_{PH}$	600V FRD 1A	SOD123F / SMA	Optional for reduced high side $P_{DT}$ (Note 1)

Note 1:  $D_{PH}$  and  $D_{PL}$  are not required if the controller has an internal Sync Boot function to regulate bootstrap voltage

- Boost PFC controller examples include NCP1616, NCP1615, and L6562A
- The circuit and tables show recommended values for the Boost PFC EZDrive circuit
  - As an option, similar to silicon MOSFET-based designs, efficiency and EMI can be further optimized with the labeled "optional circuit"



**EZDrive Circuit**

Symbol	Rec. Value	Rec. Footprint	Function
$R_{EZ}$	$\sim 10 \text{ k}\Omega$	0402 / 0603	Keep the driving voltage
$C_{EZ}$	$\sim 47 \text{ nF}$	0402 / 0603	Hold negative voltage for turning off
$Z_{EZ1}$	5.6 V Zener	SOD923F / 0603	Clamp the positive gate voltage
$Z_{EZ2}$	9.1 V Zener	SOD923F / 0603	Clamp the negative gate voltage

**Efficiency and EMI Optimization Circuit (Optional)**

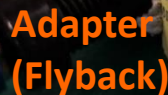
Symb ol	Rec. Value	Rec. Footprint	Function
$D_{OFF}$	20V DIODE 1A	SOD923F / 0603	Enable independent turn-off speed control
$R_{OFF}$	$0 \Omega$	0402 / 0603	Control turn-off speed

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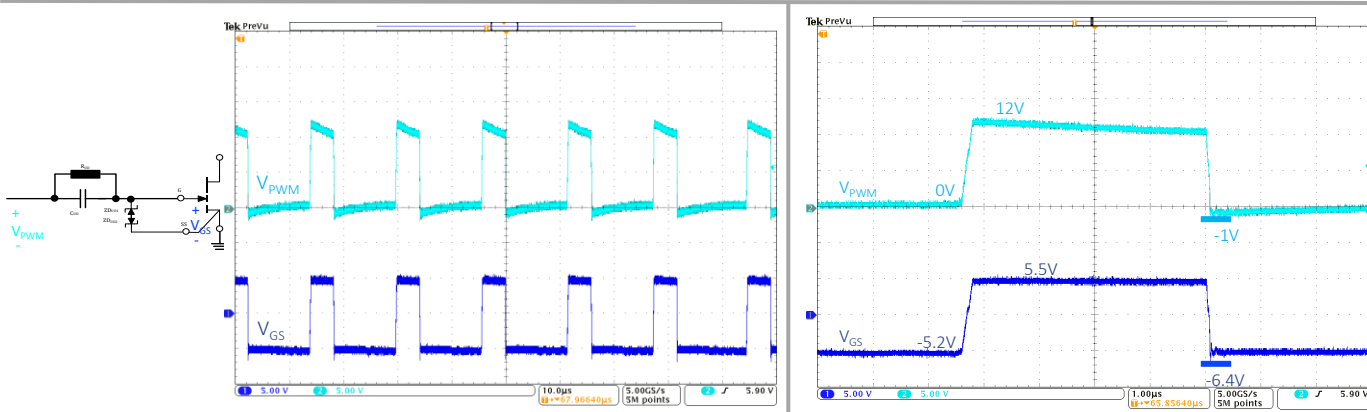
## Back side

- Populate GaN daughter card with GaN transistor and EZDrive components
- Modify off-the-shelf adapter
- Solder in GaN + EZDrive circuit daughter board



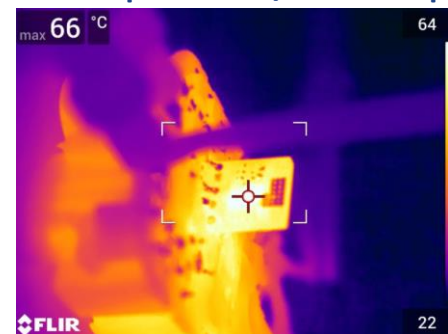
# Flyback topology verification data

## EZDrive Waveforms ( $V_{PWM}$ & $V_{GS}$ ) @ full load (18V/1.67A output)



## Temp. Distribution @ full Load

### 115Vac input at 18V/1.67A output



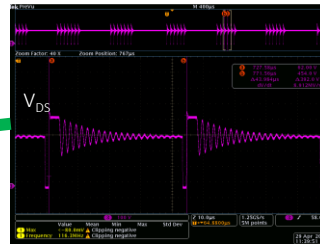
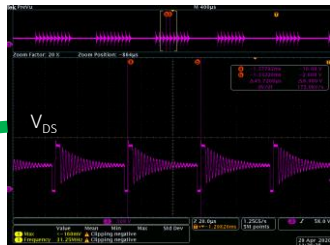
## Skip Mode Operation @ 5% Loads

Skip frequency:1.2KHZ

Pulse frequency:22KHZ

Skip frequency:1.6KHZ

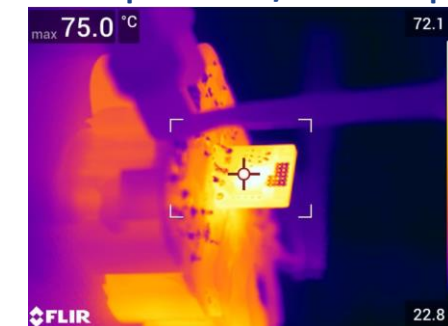
Pulse frequency:22KHZ



115Vac input, Average frequency=13KHZ

230Vac input, Average frequency=8KHZ

### 230Vac input at 18V/1.67A output



- No overshoot/undershoot on  $V_{GS}$  in all operating conditions
- Low operating temperatures

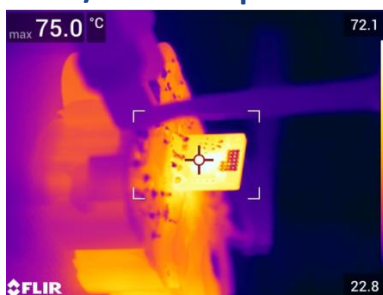
# Flyback topology verification data

Temp. Distribution@ full Load

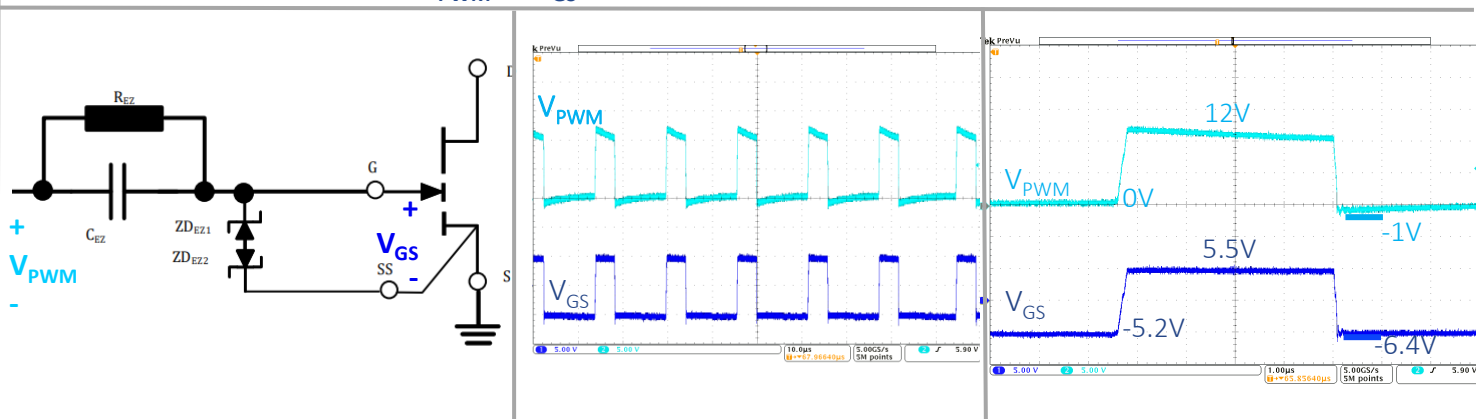
115Vac input at  
18V/1.67A output



230Vac input at  
18V/1.67A output



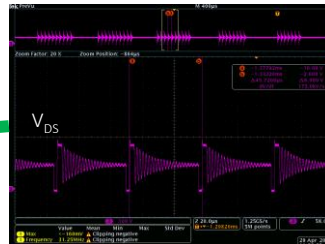
EZDrive Waveforms ( $V_{PWM}$  &  $V_{GS}$ ) @ full load (18V/1.67A output)



Skip Mode Operation @ 5% Loads

Skip frequency:1.2KHZ

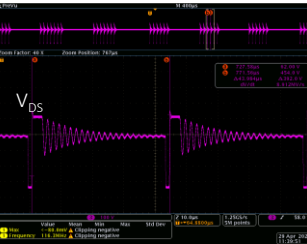
Pulse frequency:22KHZ



115Vac input, Average frequency=13KHz

Skip frequency:1.6KHZ

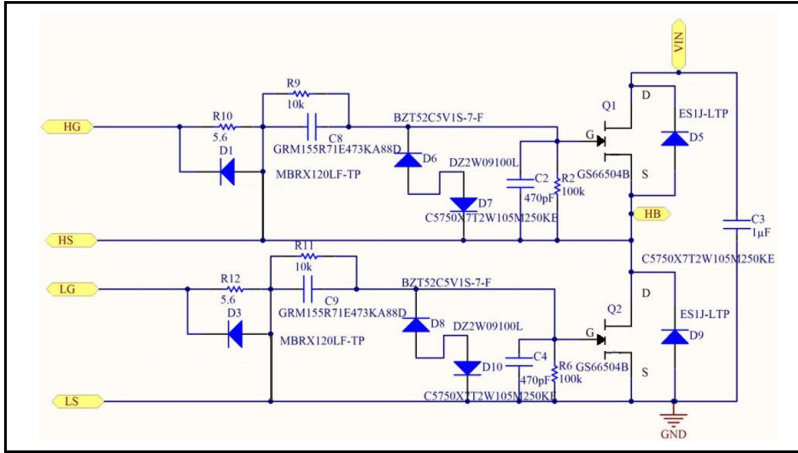
Pulse frequency:22KHZ



230Vac input, Average frequency=8KHz

- No overshoot/undershoot on  $V_{GS}$  in all operating conditions
- Low operating temperatures

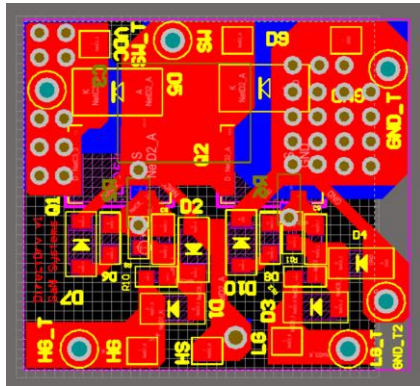
# Half Bridge LLC topology verification setup



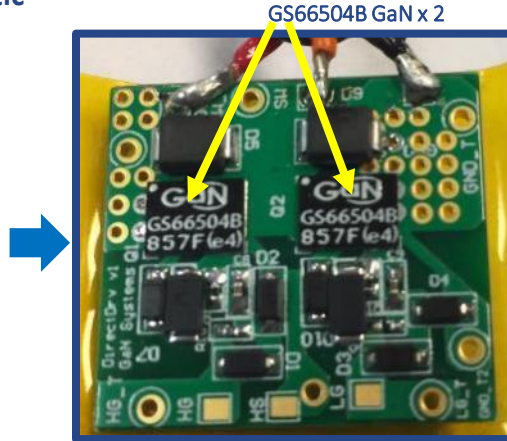
Half Bridge LLC EZDrive schematic



Test board (Top View)



Half Bridge EZDrive layout

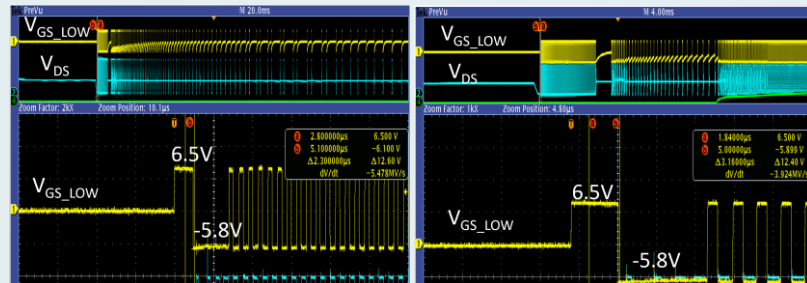


EZDrive Daughter Card



Test board (Bottom View)

# Half Bridge LLC verification data



@ no load ( $I_{out}=0A$ )

@ full load ( $I_{out}=20A$ )

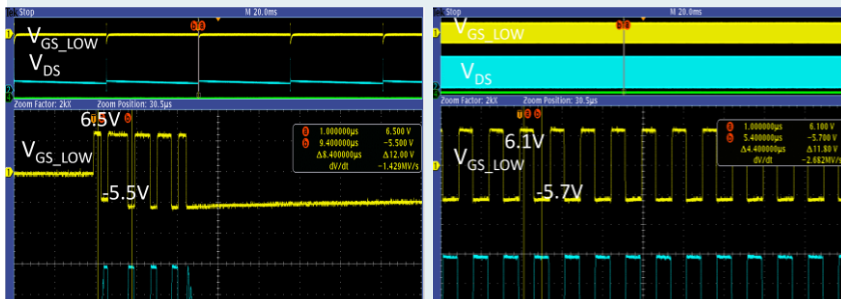
## Start-up Process



0A to 20A

20A to 0A

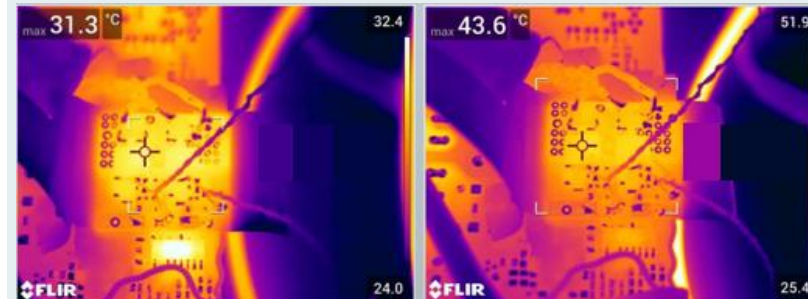
## Load Step Change



@ no load ( $I_{out}=0A$ )

@ full load ( $I_{out}=20A$ )

## Static Operation



@ half load (10A)

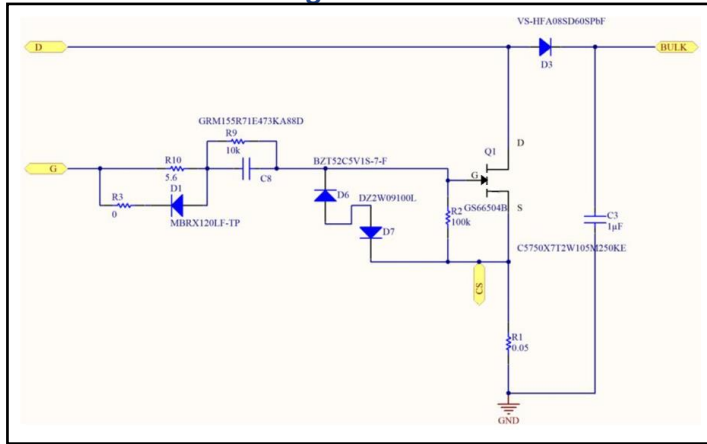
@ full load (20A)

## Temperature Distribution

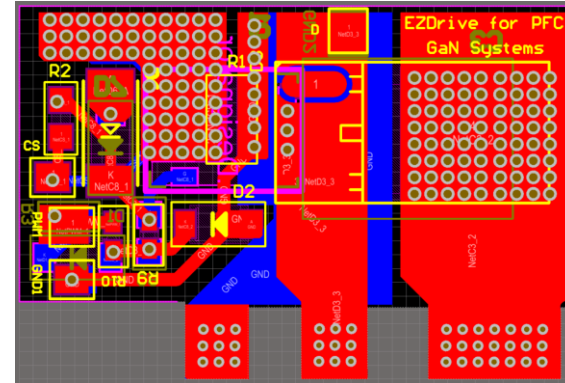
- No overshoot/undershoot on  $V_{GS}$  &  $V_{DS}$  in all operating conditions
- Low operating temperatures

# Boost PFC topology verification test setup

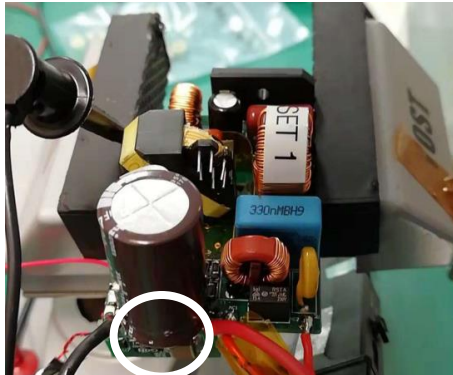
EZDrive PFC daughter card schematic



EZDrive PFC daughter card



PFC with transition-mode controller L6562A (Top View)



PFC with transition-mode controller L6562A (Side View)



650V 15A GaN Transistor: GS66504B

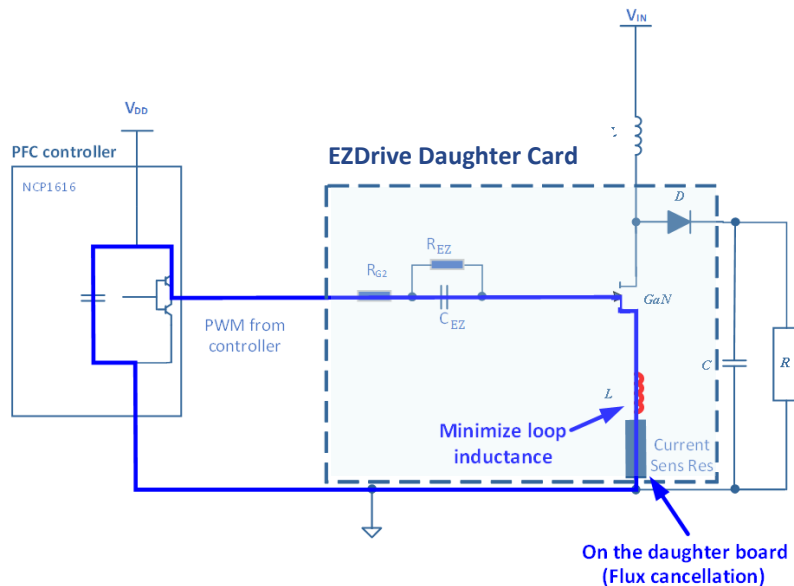


top



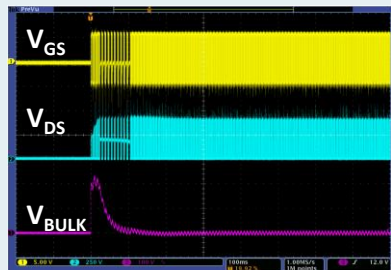
bottom

- For power greater than 65W, a daughter card is typically used in the design for improved thermal performance
- The table below provides layout recommendations

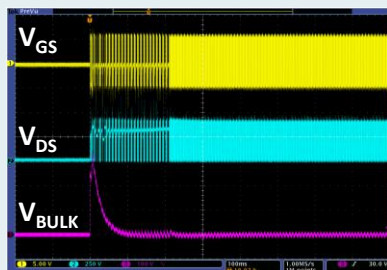


Layout recommendations	Objectives
<ul style="list-style-type: none"><li>• Shorten the trace length between the sensing resistor and Power GND</li></ul>	Reduce trace inductance
<ul style="list-style-type: none"><li>• Put the sensing resistor and GaN back-to-back on the 2-layer board</li><li>• Using a 4-layer PCB will further reduce the common inductance and result in improved thermal performance</li></ul>	Flux cancellation → reduce the mutual inductance
<ul style="list-style-type: none"><li>• Optionally use SMD current sensing resistor instead of THT</li></ul>	Reduce the parasitic inductance

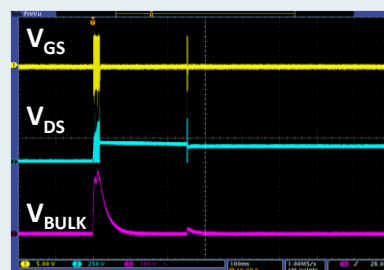
## Start-up Process



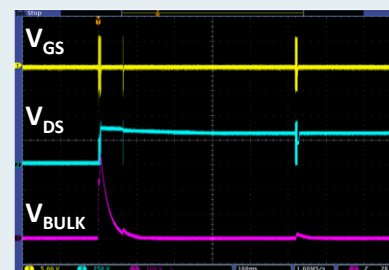
@ 110Vac & full load (400V, 0.5A)



@ 220Vac & full load (400V, 0.5A)

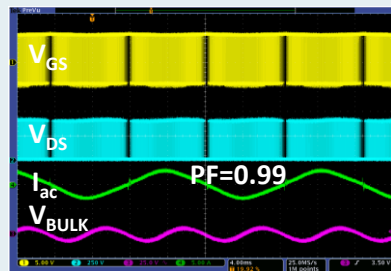


@ 110Vac & no load (400V, 0A)

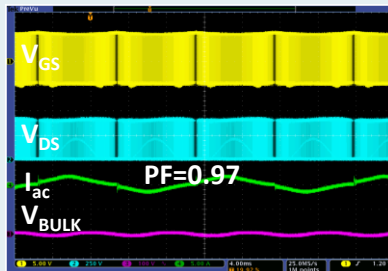


@ 220Vac & no load (400V, 0A)

## Static Operation

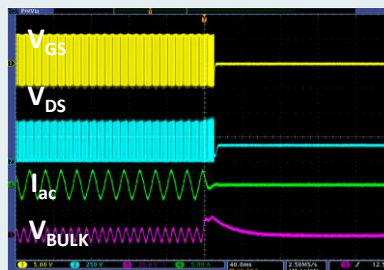


@ 110Vac & full load (400V, 0.5A)

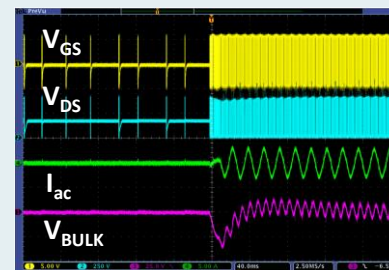


@ 220Vac & full load (400V, 0.5A)

## Load Step Change



Full load to no load (0.5A to 0A)



No load to full load (0A to 0.5A)

- No overshoot/undershoot on  $V_{GS}$  &  $V_{DS}$  in all operating conditions

- Introduction
- GaN discrete versus integrated options
- GaN Systems' solution: EZDrive circuit
- EZDrive circuit verification
- Summary

Application Considerations	Silicon MOSFETS	GaN Systems EZDrive circuit	Monolithic GaN + driver
Total BoM Cost	✓	✓	✗
Choice of devices to optimize design	✓	✓	✗
Use controller driver, eliminate redundancy	✓	✓	✗
EMI control	✓	✓	✗
Power density	✗	✓	✓



GaN Systems **EZDrive** circuit is a **low cost**, easy way to implement a GaN driving circuit with a standard MOSFET controller with integrated driver

- [illegible]

# Bodo's Power Systems®

## Using MOSFET Controllers to Drive GaN E-HEMTs





Product and application support at  
[gansystems.com](http://gansystems.com)